# 504933037 05/25/2018

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT4979783

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
NIKOLAY ARTEMIEV	05/14/2018
ALEXANDER BYKANOV	05/22/2018
JOSEPH A. DI REGOLO	05/09/2018
ANTONIO GELLINEAU	05/12/2018
JOHN HENCH	05/14/2018
ALEXANDER KUZNETSOV	05/16/2018
ANDREI VELDMAN	05/14/2018

### **RECEIVING PARTY DATA**

Name:	KLA-TENCOR CORPORATION	
Street Address:	ss: ONE TECHNOLOGY DRIVE	
City:	MILPITAS	
State/Country:	CALIFORNIA	
Postal Code:	95035	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	15974962	

#### CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone:	6503070332	
Email:	isabelle@spanolawgroup.com	
Correspondent Name:	JOSEPH S SPANO	
Address Line 1:	851 BURLWAY ROAD, SUITE 407	
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ATTORNEY DOCKET NUMBER:	KLA-107
NAME OF SUBMITTER:	JOSEPH S. SPANO
SIGNATURE:	/Joseph S. Spano/
DATE SIGNED:	05/25/2018

## **Total Attachments: 6**

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#### ASSIGNMENT OF PATENT APPLICATION

WHEREAS, we, Alexander Bykanov, 2489 Nabal Street, Escondido, CA 92025; Nikolay Artemiev, 1435 Martin Luther King Junior Way, Apt. #3, Berkeley, CA 94709; Joseph A. Di Regolo, 752 Cottonwood Court, Livermore, CA 94551; Antonio Gellineau, 865 Harrison Street, Santa Clara, California 95050; Alexander Kuznetsov, 13016 Armaga Springs Road, Austin, TX 78727; Andrei Veldman, 487 Texas Oak Terrace, Sunnyvale, CA 94086; John Hench, 26755 Adams Road, Los Gatos, California 95033, (hereinafter referred to as ASSIGNORS), having post office addresses that follow our names, are the joint inventors of the invention described and claimed in the specification forming part of the United States patent application entitled "Methods And Systems For Characterization Of An X-Ray Beam With High Spatial Resolution," which was filed on May 9, 2018, and now has U.S. Application Ser. No. 15/974,962;

WHEREAS, KLA-Tencor Corporation, (hereafter referred to as ASSIGNEE), a corporation organized under the laws of Delaware and having a place of business at One Technology Drive, Milpitas, California 95035, is desirous of acquiring the entire right, title, and interest in and to the invention and in and to any letters patents that may be granted therefor in the United States and in any and all foreign countries;

NOW. THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign, and transfer unto said ASSIGNEE, its successors and assigns, the entire right, title, and interest in and to said invention, said application and any and all letters patents which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE, its successors and assigns, and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty, or otherwise, said invention, application and all letters patents on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer, and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patents on said invention to ASSIGNEE, its successors and assigns. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patents on said invention, for litigation regarding said letters patents, or for the purpose of protecting title to said invention or letters patents therefor.

IN WITNESS WHEREOF, We have hereunto signed our names on the day and year set forth below.

Inventor's Signature

Asso

Inventor's Signature

Alexander Bykanov Inventor's Printed Name

Date

Page 1 of 2

Nikolay Artemiev Inventor's Printed Name

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IN WITNESS WHEREOF, We have hereunto signed our names on the day and year set forth below.

Inventor's/Signature

Alexander Bykanov Inventor's Printed Name

5/22/2018

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Nikolay Artemiev Inventor's Printed Name

Date

Page 1 of 2

inventor's Signature

Joseph A. Di Regolo Inventor's Printed Name

<u>May 9,7018</u> Bate

Inventor's Signature

Antonio Gellineau Inventor's Printed Name

Date

Inventor's Signature

Alexander Kuznetsov Inventor's Printed Name

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Andrei Veldman Inventor's Printed Name

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Inventor's Signature

John Hench Inventor's Printed Name

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Inventor's Signature

Joseph A. Di Regolo Inventor's Printed Name

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Antonio Gellineau Inventor's Printed Name 05/12/2018

Date

Inventor's Signature

Alexander Kuznetsov Inventor's Printed Name

Date

Inventor's Signature

Andrei Veldman Inventor's Printed Name

Date

Inventor's Signature

John Hench Inventor's Printed Name

Date

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Inventor's Signature	Antonio Gellineau Inventor's Printed Name	Date
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	Alexander Kuznetsov	
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	Andrei Veldman	
Inventor's Signature	Inventor's Printed Name	Date
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Joseph A. Di Regolo Inventor's Printed Name

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Antonio Gellineau Inventor's Printed Name

Date

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Alexander Kuznetsov Inventor's Printed Name

0.5/16/2018 Date

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Andrei Veldman Inventor's Printed Name

Date

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John Hench Inventor's Printed Name

Date